

PATENT ASSIGNMENT

Electronic Version v1.1

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Leeds Electronic Engineering, Ltd.	11/03/2008
RECEIVING PARTY DATA	
Name:	New Day Investment Limited
Street Address:	6 Yip Fat Street, Flat C, 21st Floor
Internal Address:	Yally Industrial Bldg.
City:	Wong Chuk Hang
State/Country:	HONG KONG
PROPERTY NUMBERS Total: 3	
Property Type	Number
Patent Number:	7372362
Patent Number:	6992579
Patent Number:	6952166
CORRESPONDENCE DATA	
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ATTORNEY DOCKET NUMBER:	P-129015 /129015.2 TES
NAME OF SUBMITTER:	Thomas E. Sisson
Total Attachments: 2 source=Leeds#page1.tif source=Leeds#page2.tif	

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PATENT

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ASSIGNMENT

WHEREAS, LEEDS ELECTRONIC ENGINEERING, LTD., located in Hong Kong, is owner of the following listed inventions entitled

- (1) HIGH-SPEED ELECTRICAL DATA TRANSMISSION SYSTEM, for which I have executed an application for a patent filed with the United States Patent and Trademark Office, December 12, 2007, Serial No. 12/001,725;
- (2) SECURITY ALARM SYSTEM HAVING MINIMAL WIRING TO CCTV CAMERA, U.S. Patent No. 7,372,362, issued May 13, 2008 (Serial No. 11/392,344);
- (3) BURGLAR ALARM SYSTEM HAVING REDUCED WIRING, U.S. Patent No. 6,992,579 (Serial No. 10/748,575);
- (4) BURGLAR ALARM SYSTEM HAVING REDUCED WIRING, U.S. Patent No. 6,952,166 (Serial No. 10/081,824)

WHEREAS, NEW DAY INVESTMENT LIMITED, located in Hong Kong, ASSIGNEE, is desirous of obtaining the entire right, title and interest in, to and under the same inventions.

NOW, THEREFORE, in consideration of the sum of One Dollar (\$1.00) to the said ASSIGNOR in hand paid, and other good and valuable consideration, the receipt of which is hereby acknowledged, I, the said ASSIGNOR, have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said ASSIGNEE, its successors, legal representatives and assigns, the entire right, title and interest in, to and under the said invention, and the said United States application and all divisions, renewals and continuations thereof, and all Patents of the United States which may be granted thereon and all reissues thereof; and all applications for industrial property protection, including, without limitation, all applications for patents, utility models, and designs which may hereafter be filed for said invention in any country or countries foreign to the United States, together with the right to file such applications and the right to claim for the same the priority rights derived from said United States application under the Patent Laws of the United States, the International Convention for the Protection of Industrial Property, or any other international agreement or the domestic laws of the country in which any such application is filed, as may be applicable; and all forms of industrial property protection, including, without limitation, patents, utility models and design which may be granted for said invention in any country or countries foreign to the United States and all extensions, renewals and reissues thereof;

AND I HEREBY authorize and request the Commissioner of Patents of the United States, and any official of any country or countries foreign to the United States, whose duty it is to issue patents or other evidence or forms of industrial property protection on applications as aforesaid, to issue the same to the said ASSIGNEE, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND I HEREBY covenant that I have full right to convey the entire interest herein assigned, and that I have not executed, and will not execute, any agreement in conflict herewith.

AND I HEREBY further covenant and agree that I will communicate to the said ASSIGNEE, its successors, legal representatives and assigns, any facts known to me respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisions, continuing and reissue applications, make all rightful oaths and generally do everything possible to aid the said ASSIGNEE, its successors, legal representatives and assigns, to obtain and enforce proper patent protection for said invention in all countries.

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this 3rd day of Nov 2008

LEEDS ELECTRONIC ENGINEERING, LTD., OWNER

By: _____

(Signature)

John Kam-Ho LEE

(Printed Name)

Title: _____

DIRECTOR